

1 Article

# 2 ELECTRODEPOSITION OF 3 COPPER/CARBONOUS NANOMATERIAL 4 COMPOSITE COATINGS FOR 5 HEAT-DISSIPATION MATERIALS

6 Yasuki Goto <sup>1</sup>, Yota Kamebuchi <sup>2</sup>, Takeshi Hagio <sup>1,3</sup>, Yuki Kamimoto <sup>3</sup>, Ryoichi Ichino <sup>1,3,4,\*</sup> and  
7 Takeshi Bessho <sup>5</sup>

8 <sup>1</sup> Department of Chemical Systems Engineering, Graduate School of Engineering, Nagoya University,  
9 Furo-cho, Chikusa-ku, Nagoya 464-8603, Japan

10 <sup>2</sup> Department of Materials Science and Engineering, Graduate School of Engineering, Nagoya University,  
11 Furo-cho, Chikusa-ku, Nagoya 464-8603, Japan

12 <sup>3</sup> Green Mobility Research Institute, Institutes of Innovation for Future Society, Nagoya University, Furo-cho,  
13 Chikusa-ku, Nagoya 464-8603, Japan

14 <sup>4</sup> Institute of Materials and Systems for Sustainability, Nagoya University, Furo-cho, Chikusa-ku, Nagoya  
15 464-8603, Japan

16 <sup>5</sup> Toyota Motor Corporation, 1 Toyota-Cho, Toyota City, Aichi Prefecture 471-8571, Japan

17 \* Correspondence: ichino.ryoichi@material.nagoya-u.ac.jp; Tel.: +81-52-747-3352

18 **Abstract:** Carbonous nanomaterials are promising additives for composite coatings for  
19 heat-dissipation materials because of their excellent thermal conductivity. Here, copper/carbonous  
20 nanomaterial composite coatings were prepared using nanodiamond (ND) as the carbonous  
21 nanomaterial. The copper/ND composite coatings were electrically deposited onto copper  
22 substrates from a continuously stirred copper sulfate coating bath containing NDs. NDs were  
23 dispersed by ultrasonic treatment, and the initial bath pH was adjusted by adding sodium  
24 hydroxide solution or sulfuric acid solution before electrodeposition. The effects of various coating  
25 conditions—the initial ND concentration, initial bath pH, stirring speed, electrical current density,  
26 and the amount of electricity—on the ND content of the coatings were investigated. Furthermore,  
27 the surface of the NDs was modified by hydrothermal treatment to improve ND incorporation. A  
28 higher initial ND concentration and a higher stirring speed increased the ND content of the  
29 coatings, whereas a higher initial bath pH and a greater amount of electricity decreased it. The  
30 electrical current density showed a minimum ND content at approximately 5 A/dm<sup>2</sup>.  
31 Hydrothermal treatment, which introduced carboxyl groups onto the ND surface, improved the  
32 ND content of the coatings. A copper/ND composite coating with a maximum of 3.85 mass% ND  
33 was obtained.

34 **Keywords:** copper; carbonous nanomaterial; composite coating; heat-dissipation material;  
35 nanodiamond  
36

## 37 1. Introduction

38 Heat management has recently become a major issue in the electronics industry because of the  
39 continuous miniaturization of devices. This miniaturization has led to increased power densities;  
40 thus, effective heat removal is important to maintain and improve their performance [1-3]. Copper  
41 or its alloys have been widely used in the electronics industry as heat-dissipation materials because  
42 of its excellent thermal conductivity [3-5]. However, heat-dissipation materials with higher thermal  
43 conductivities are required for future electronics that will operate at much higher power densities.

44 Carbonous materials such as graphite, graphene, carbon nanofibers, carbon nanotubes, and  
45 diamonds are promising candidates for next-generation heat-dissipation materials because their

46 thermal conductivity is 2 to 10 times greater than that of copper [3,5-10]. Various monolithic  
47 carbonous materials, including synthetic graphite sheets [6], graphite foams [8], a vertically aligned  
48 hybrid material of diamond thin platelets covered with a crystalline graphite layer [9], and highly  
49 oriented pyrolytic graphite [10], have been reported to be good heat-dissipation materials. Although  
50 previous studies have demonstrated the effectiveness of carbonous materials as heat-dissipation  
51 materials, using them in a monolithic form is difficult because of their low formability and brittle  
52 nature [8,10].

53 Composite coatings with carbonous nanomaterials incorporated into a metal matrix are  
54 receiving increasing attention for use in applications such as low-friction coatings [11,12],  
55 wear-resistant coatings [11-14], and corrosion-resistant coatings [11-15]. Embedding carbonous  
56 materials into a metal matrix can overcome some of the disadvantages associated with carbonous  
57 materials. Copper coatings for heat-dissipation applications are also expected to be improved  
58 through incorporation of carbonous nanomaterials because of their excellent aforementioned  
59 thermal properties. Among the various carbonous nanomaterials, nanosized diamond—so-called  
60 nanodiamond (ND)—is the most promising additive for composite copper coatings because of its  
61 especially high and isotropic thermal conductivity [16]. Unlike most carbonous nanomaterials that  
62 exhibit anisotropic thermal conductivity, NDs do not require control of their orientation in  
63 composite coatings.

64 Composite coatings can be formed by electrolytic or electroless deposition from a coating bath  
65 containing additives, and the dispersibility of the additives is a key factor for achieving  
66 homogeneous and high additive incorporation [17,18]. To form copper/ND composite coatings, NDs  
67 should be highly dispersed in the coating bath and the ND size should be small to facilitate their  
68 effective incorporation [17-19]. Dispersants are often used to attain highly dispersed suspensions in  
69 composite coatings [18-20]; however, the thermal conductivity of the composite coating is  
70 deteriorated through inclusion of the dispersants [20]. A different strategy is thus necessary to  
71 improve the dispersibility of NDs. Surface modification is a prospective approach to improve the  
72 dispersibility of carbonous nanomaterials [21-23], and hydrothermal treatment in strong inorganic  
73 acids is known to enable surface modification of carbonous nanomaterials [23-25].

74 Even though copper/ND composite coatings are expected to be prospective heat-dissipation  
75 materials, the effects of the electrodeposition coating conditions and the surface modification of ND  
76 are not well known. In the present study, copper/ND composite coatings were prepared by  
77 electrodeposition and the effect of various coating conditions (i.e., the initial ND concentration,  
78 initial bath pH, stirring speed, electrical current density, and the amount of electricity) on the ND  
79 content of the coating was investigated. Furthermore, surface modification of ND by hydrothermal  
80 treatment was carried out to improve ND incorporation into the coatings.

## 81 2. Materials and Methods

### 82 2.1. Materials

83 Copper sulfate pentahydrate ( $\text{CuSO}_4 \cdot 5\text{H}_2\text{O}$ : Nacalai Tesque, Inc.), nitric acid ( $\text{HNO}_3$ : Nacalai  
84 Tesque, Inc.), concentrated sulfuric acid ( $\text{H}_2\text{SO}_4$ : Nacalai Tesque, Inc.), and sodium hydroxide  
85 ( $\text{NaOH}$ : Nacalai Tesque, Inc.) were used as received. Purified detonation NDs, which are  
86 agglomerates composed of primary particles approximately 5 nm in diameter, were acquired from  
87 NOF Corporation. Surface-modified NDs were prepared by hydrothermal treatment of NDs in  
88 concentrated  $\text{H}_2\text{SO}_4$  solutions.  $\text{H}_2\text{SO}_4$  was selected to avoid contamination by other anions. A certain  
89 amount of NDs was suspended in 5 mL of concentrated  $\text{H}_2\text{SO}_4$  in a Teflon container, which was  
90 subsequently sealed in a stainless-steel jacket for hydrothermal treatment at 493 K for 2 h.

### 92 2.2. Preparation of copper/ND composite coatings

93 Copper substrates (Yamamoto-MS Co., Ltd., B-60 hull cell cathode plates) were masked, leaving  
94 an area of 400 mm<sup>2</sup> (20 mm × 20 mm) for electrodeposition. The copper substrates were washed with

95 diluted HNO<sub>3</sub> solution for 10 s and completely dried after being rinsed with distilled water. The  
 96 copper substrates, a platinum wire, and an Ag/AgCl electrode in a saturated KCl solution were used  
 97 as the cathode, anode, and reference electrode, respectively. A 0.1 M or 1 M CuSO<sub>4</sub> bath was  
 98 prepared by dissolving CuSO<sub>4</sub>·5H<sub>2</sub>O in distilled water. A certain amount of ND was added to the  
 99 copper sulfate bath of 50 mL. When nontreated NDs were used, the pH of the bath was adjusted  
 100 using a solution of NaOH or H<sub>2</sub>SO<sub>4</sub>. By contrast, when surface-modified NDs were used, the NDs  
 101 were added along with the 5 mL of concentrated H<sub>2</sub>SO<sub>4</sub> solution used for hydrothermal treatment;  
 102 however, the total bath volume was maintained at 50 mL, and no further pH adjustment was carried  
 103 out. The NDs were then ultrasonically suspended for 1 h using an ultrasonic homogenizer (Sonics &  
 104 Materials, Inc., VC-505, 20 kHz, 200 W) to disperse the NDs.

105 Electrodeposition was performed at room temperature using a galvanostat (Hokuto Denko  
 106 Corp., HZ-5000), and the stirring speed, current density, and amount of electricity were varied. The  
 107 effects of the initial ND concentration, initial pH, stirring speed, current density, amount of  
 108 electricity, and the surface modification of the NDs were investigated. The experimental conditions  
 109 are shown in Table 1. Two to fifteen replicate experiments were performed under each set of  
 110 investigated conditions, and their average value was adopted.

111 **Table 1.** Coating conditions used in this study

Exp. No.	Initial CuSO <sub>4</sub> conc. [M]	Initial ND conc. [g/L]	Initial pH	Stirring speed [rpm]	Current density [A/dm <sup>2</sup> ]	Amount of electricity [C]	Surface modification of ND
1	0.1	0–30	2	500	100	20	–
2	1	3	0–4	500	10	20	–
3	0.1	3	2	250–750	100	20	–
4	1	20	2	500	1–25	20	–
5	0.1	3	2	500	100	10–100	–
6	0.1	3	2 or ≤0 <sup>1</sup>	500	100	20	None or HT <sup>2</sup>

112 <sup>1</sup>Below detection limit.

113 <sup>2</sup>HT: Hydrothermal treatment at 493 K for 2 h in concentrated H<sub>2</sub>SO<sub>4</sub> solution.

114

### 115 2.3. Characterization of copper/ND composite coatings

116 The ND content of the coatings was evaluated via a combustion method using a carbon–sulfur  
 117 simultaneous analysis device (Horiba, Ltd., EMIA-510). The coating was fired at 1623 K along with  
 118 the copper substrate under an oxygen atmosphere, and the generated gas was measured by infrared  
 119 absorption. The concentrations of the composite components were calculated using the following  
 120 equations:

$$V_t = \frac{m_c}{M_t} \times 100 = \frac{V_c M_c + V_s M_s}{M_t} \approx \frac{V_c M_c}{M_t} \quad (\because V_s \approx 0) \quad (1)$$

$$V_c = V_t \times \frac{M_t}{M_c} \quad (2)$$

121 where  $V_t$ ,  $V_c$ , and  $V_s$  are the carbon contents of the test piece [mass%], coating [mass%], and the  
 122 substrate [mass%], respectively;  $M_t$ ,  $M_c$ , and  $M_s$  are the mass of the test piece [g], coating [g], and the  
 123 substrate [g], respectively; and  $m_c$  is the overall carbon mass in the test piece [g].

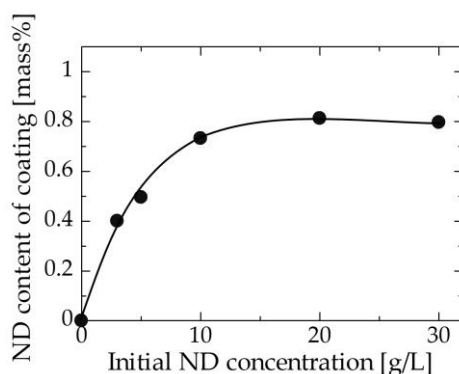
124 The microstructure of the coatings was observed using a scanning electron microscope (SEM:  
 125 JEOL Ltd., JSM-6330F) operating at 15 kV. The effect of the hydrothermal treatment on the NDs was  
 126 evaluated on the basis of the functional groups on the surface of the NDs via Fourier-transform  
 127 infrared spectroscopy (FT-IR: PerkinElmer, Inc., Spectrum 100s).

### 128 3. Results and Discussion

129 The effect of initial ND concentration, initial pH, stirring speed, current density, amount of  
130 electricity, and surface modification of NDs is discussed on the basis of the results of each of the  
131 experiments detailed in Table 1.

#### 132 3.1. Effect of initial ND concentration of the coating bath

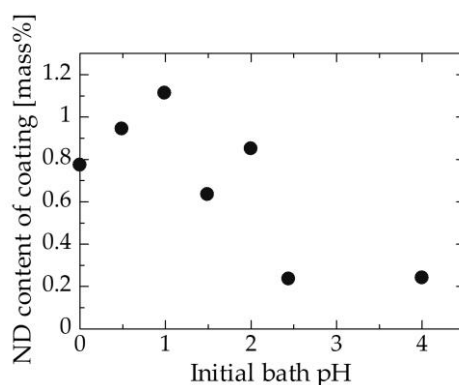
133 The effect of the initial ND concentration on the ND content of the final coating is shown in Fig.  
134 1. The ND content in the coating increases with increasing initial ND concentration in the bath and  
135 finally reaches a plateau value of 0.8 mass% at approximately 10 g/L under this set of experimental  
136 conditions. The greater incorporation of NDs with increasing initial ND content is explained as  
137 follows. When the initial ND concentration increases, more NDs are transported to the surface of the  
138 copper substrate; thus, more NDs can be incorporated. However, at higher ND concentrations,  
139 where the surface becomes nearly covered with NDs, the NDs remaining in the bath can no longer  
140 approach the substrate surface easily because it is covered with NDs. The interactions or collisions of  
141 NDs in the bath with the NDs on the surface of the substrate reach an equilibrium condition and  
142 prevent a further increase in the amount of incorporated NDs. An initial concentration of 10 g/L  
143 appears to correspond to the concentration where complete surface coverage by NDs is achieved.  
144 Similar trends have been reported for composite coatings in various systems such as a  
145 copper–multiwalled carbon nanotube system [20] and a nickel–aluminum nitride system [26].  
146



147 **Figure 1.** Relation between the initial ND concentration in the bath and the ND content of the coating

#### 148 3.2. Effect of initial pH of the coating bath

149 The effect of initial pH on the ND content of the coating is shown in Fig. 2. The range of pH in  
150 this experiment was decided to be 0 to 4 because copper hydroxide formed in the coating bath when  
151 the pH was increased to values greater than 4. Fig. 2 shows that more ND particles were  
152 incorporated at lower pH values, especially when the pH was less than 2. The drastic increase in ND  
153 content in the coating below pH 2 may be caused by several factors. One factor is the effect of surface  
154 functional groups on the ND. ND is known to have various functional groups on its surface [21].  
155 Conceivably, excess protons ( $H^+$ ) may cover the ND surface when an acidic solution contacts these  
156 functional groups on the ND surface, imparting the ND with a positive charge, which promotes its  
157 movement toward the cathode side. Another possibility is the effect of zeta potential. The zeta  
158 potential of detonation NDs without surface modification has been reported to be positive at low pH  
159 levels [22]. A positive zeta potential would also promote the movement of NDs to the cathode side.  
160

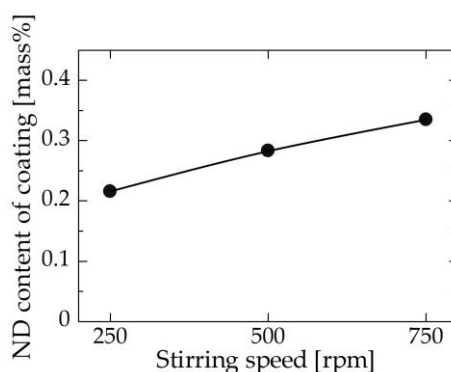


161 **Figure 2.** Relation between the initial pH of the bath and the ND content of the coating

162 *3.3. Effect of stirring speed of the coating bath*

163 Figure 3 shows the relation between the stirring speed and the ND content of the coating at a  
 164 fixed bath ND concentration of 3 g/L. The ND content in the coating increased with increasing  
 165 stirring speed in the range investigated in this experiment (Exp. No. 3, Table 1). This behavior is  
 166 attributed to the increase in frequency of NDs approaching the substrate. When the stirring speed is  
 167 low, the concentration of NDs near the coating surface might decrease after deposition begins as a  
 168 consequence of the adsorption rate of ND onto the substrate surface being higher than the feed rate.  
 169 In addition, insufficient convection would cause incomplete dispersion of the NDs and may further  
 170 lead to aggregation of the NDs. Incomplete dispersion or aggregation might decrease the number of  
 171 NDs transferred to the cathode by gravity settling, thereby lowering the final ND content of the  
 172 coating.

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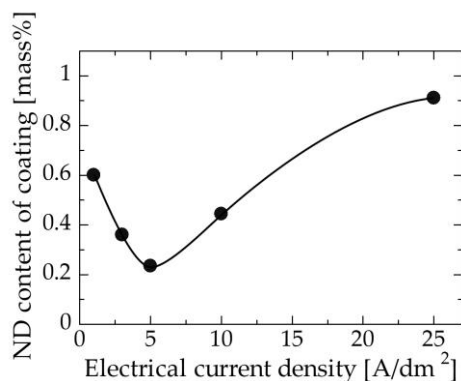


174 **Figure 3.** Relation between the stirring speed and the ND content of the coating

175 *3.4. Effect of current density during electrodeposition*

176 The effect of the current density during electrodeposition on the ND content of the coating is  
 177 shown in Fig. 4. Current density can be interpreted as the deposition rate. The ND content decreased  
 178 with increasing current density, reached a minimum of approximately 0.23 mass% at 5 A/dm<sup>2</sup>, and  
 179 then increased thereafter. The existence of a minimum value may indicate a change in the dominant  
 180 mechanism. The following mechanism is proposed. In general, the particle content in composite  
 181 coatings is determined by the competition between the deposition rate of the metal matrix and the  
 182 adsorption rate of the additive particles. In the range from 1 to 5 A/dm<sup>2</sup>, the adsorption of NDs onto  
 183 the substrate surface may have become dominant, resulting in an increase in the ND content of the  
 184 coating at especially low current densities. A similar behavior has been observed in composite  
 185 coatings that follow the Guglielmi's model [27]. By contrast, when the current density is greater than  
 186 5 A/dm<sup>2</sup>, adsorption of NDs must have been promoted by the high overpotential resulting from the  
 187 increase in current density [28], thereby enhancing the incorporation of NDs into the coating.

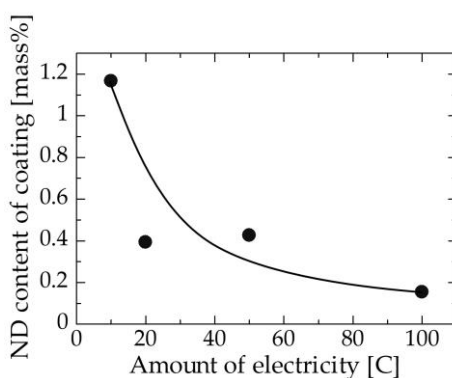
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189 **Figure 4.** Relation between the current density and the ND content of the coating

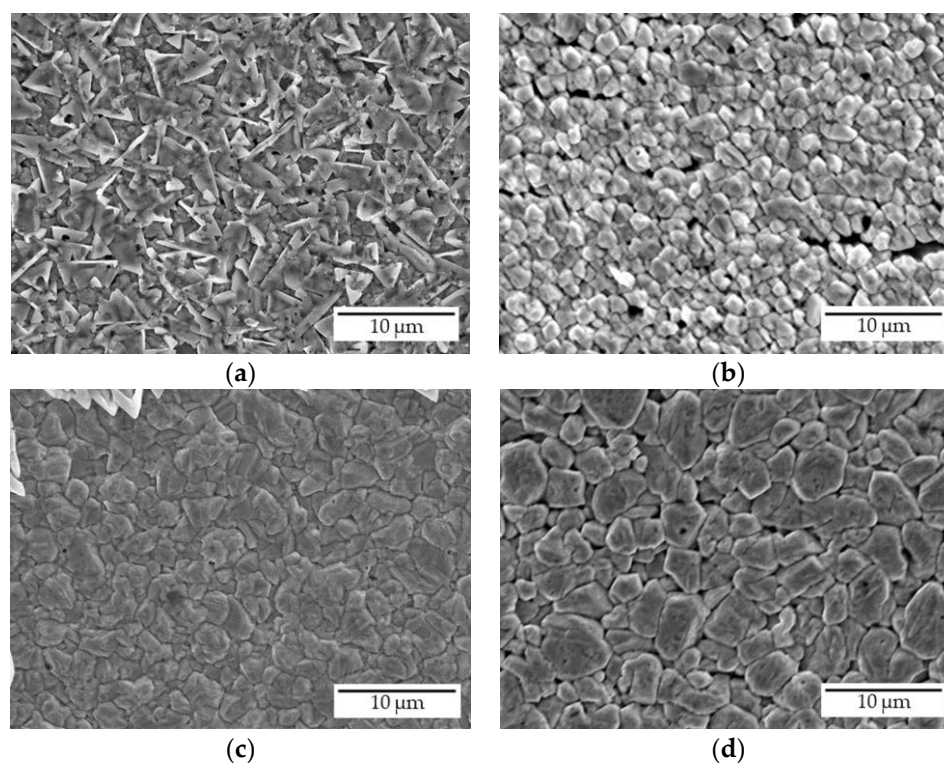
190 *3.5. Effect of the amount of electricity used for electrodeposition*

191 Figure 5 shows the relation between the amount of electricity and the ND content of the coating.  
 192 The amount of electricity nearly corresponds to the thickness of the coating. Coatings deposited  
 193 using relatively small amounts of electricity, i.e., the thinner coatings, contained more ND particles  
 194 compared with those deposited using larger amounts of electricity, i.e., thicker coatings. These  
 195 results suggest that NDs were incorporated during the early step of electrodeposition and were  
 196 unevenly distributed in the thickness direction. This may be because NDs poorly adsorb onto  
 197 substrates that exhibits substantial roughness due to their difficulty in entering the dents. SEM  
 198 observation of the surface was conducted to investigate the change of the surface morphology of the  
 199 coating when the amount of electricity was varied. As evident in the surface SEM images (Fig.  
 200 6(a)–(d)), the grain size of the deposited copper matrix was small when the amount of electricity was  
 201 small and increased with increasing amount of electricity. The surface roughness seemed to increase  
 202 as grains became larger. The ND adsorption onto the coating surface was hindered by the increase in  
 203 surface roughness corresponding to the increase in the amount of electricity. Such a change in  
 204 surface morphology of the coating may be responsible for the decrease in the ND content of the  
 205 coating.  
 206



207 **Figure 5.** Relation between the amount of electricity and the ND content of the coating

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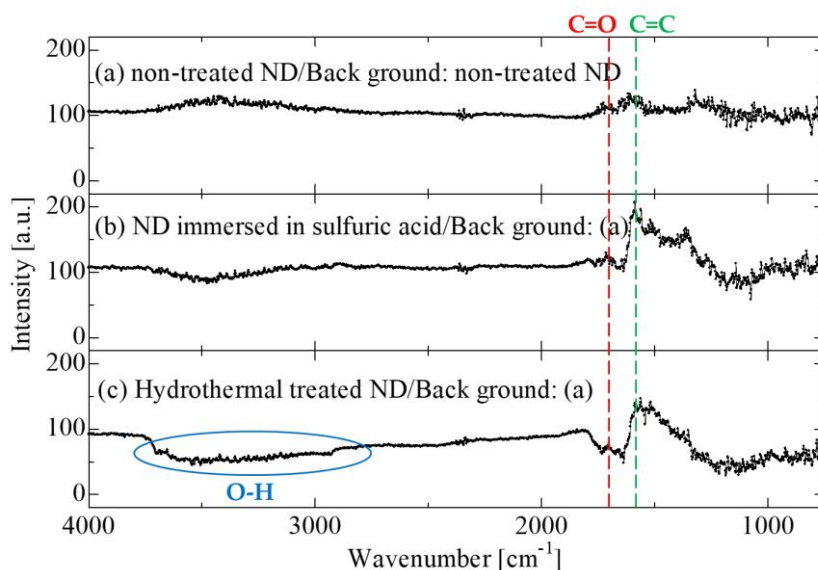


209 **Figure 6.** Surface SEM images of composite coatings deposited at an amount of electricity of (a) 10 C,  
210 (b) 20 C, (c) 50 C, and (d) 100 C

### 211 3.6. Effect of the surface modification of NDs

#### 212 3.6.1. Characterization of surface-modified NDs

213 Surface modification of NDs was carried out by hydrothermal treatment at 493 K for 2 h in  
214 concentrated  $\text{H}_2\text{SO}_4$  solution. The surface-modified NDs were characterized using FT-IR  
215 measurements because acid treatment has been reported to introduce functional groups onto the  
216 surface of NDs. The obtained FT-IR spectra are shown in Fig. 7. NDs that were only immersed in  
217 sulfuric acid were also characterized for comparison. The peak near  $1600\text{ cm}^{-1}$  indicates a decrease in  
218 the number of C=C bonds, and the peak at approximately  $1700\text{ cm}^{-1}$  indicates an increase in the  
219 abundance of C=O bonds. In Fig. 7(c), a peak from approximately  $3500\text{ cm}^{-1}$  to approximately  $2500$   
220  $\text{cm}^{-1}$  is also observed. This peak may indicate an increase in the number of -OH bonds derived from  
221 the carboxyl groups. These results show that the numbers of -OH bonds and -C=O bonds increased  
222 on the surface of the ND particles as a result of the hydrothermal treatment, whereas the number of  
223 C-C bonds decreased. Consequently, the results suggest that carboxyl groups were introduced onto  
224 the NDs as a result of the hydrothermal treatment [29]. Jiang et al. have reported that oxidation  
225 treatment of activated carbon using concentrated  $\text{H}_2\text{SO}_4$  at 533 K introduced mainly carboxyl groups  
226 (COO-species) and hydroxyl groups (-OH) [30]. A similar phenomenon may have occurred in the  
227 present study.

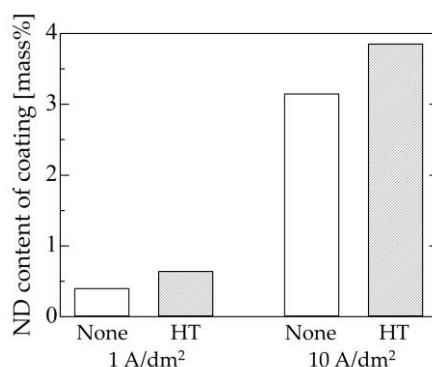


228 **Figure 7.** Peak obtained from FT-IR measurements

229 3.6.2. Effect of surface modification on the ND content of coatings

230 The ND contents of coatings deposited using surface-modified NDs are summarized in Fig. 8.  
 231 The ND content of the coating increased by 30 to 60% when surface-modified NDs were used.  
 232 Hydrothermal treatment has been reported to improve the colloidal stability of the ND particles in  
 233 water [31], which likely led to our observed increase in the amount of NDs incorporated. Moreover,  
 234 the positive charge induced by the excess protons, as discussed in in section 3.2, may have been  
 235 intensified by the additional carboxyl groups introduced by the hydrothermal treatment. Using the  
 236 hydrothermally treated ND particles under conditions of a 0.1 M CuSO<sub>4</sub> bath, an initial ND  
 237 concentration of 3 g/L, a stirring speed of 500 rpm, a current density of 10 A/dm<sup>2</sup>, and an amount of  
 238 electricity of 20 C, a coating with an ND content as high as 3.85 mass% ND, corresponding to nearly  
 239 10 vol% ND, was attained.

240



241 **Figure 8.** Effect of hydrothermal treatment on the ND content of the coating

242 **4. Conclusions**

243 In this study, copper/ND composite coatings were prepared by electrodeposition and the  
 244 effects of various coating conditions, initial ND concentration, initial bath pH, stirring speed,  
 245 electrical current density, and the amount of electricity on the ND content of the coatings were  
 246 investigated. Furthermore, surface modification of the ND by hydrothermal treatment was  
 247 performed to improve ND incorporation. The following results were obtained.

- 248 • The ND content of the coatings increased when the NDs approached the substrate at high  
 249 frequency.



- 250 • NDs were found to be unevenly distributed in the thickness direction of the coatings.  
251 • Furthermore, surface modification of NDs via hydrothermal treatment in concentrated H<sub>2</sub>SO<sub>4</sub>  
252 solution improved the ND content of the coatings.  
253 • Surface functional groups introduced by the hydrothermal treatment appeared to play an  
254 important role in the incorporation of NDs.

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256 **Author Contributions:** Y. Kamebuchi mainly performed the experiments and analyses; Y. Goto and T. Hagio  
257 considered the data and wrote the paper; Y. Kamimoto and R. Ichino conceived and designed the experiments;  
258 T. Bessho performed part of the analyses and gave important advice throughout the experiments.

259 **Conflicts of Interest:** The authors declare no conflict of interest.

## 260 References

- 261 1. Anandan, S.S.; Ramalingam, V. Thermal management of electronics: A review of literature. *Therm. Sci.*  
262 **2008**, *12*, 5–26, DOI: 10.2298/TSCI0802005A.
- 263 2. Li, J.; Li, X.; Fan, C.; Yao, H.; Chen, X.; Liu, Y. Study on the preparation of a high-efficiency carbon fiber  
264 dissipating coating. *Coatings* **2017**, *7*, 94, DOI: 10.3390/coatings7070094.
- 265 3. Silvain, J.F.; Veillère, A.; Lu, Y. Copper-carbon and aluminum-carbon composites fabricated by powder  
266 metallurgy processes. *J. Phys.: Conf. Ser.* **2014**, *525*, 012015, DOI: 10.1088/1742-6596/525/1/012015.
- 267 4. Koráb, J.; Štefánik, P.; Kavecký, Š.; Šebo, P.; Korb, G. Thermal conductivity of unidirectional copper  
268 matrix carbon fibre composites. *Composites: part A* **2002**, *33*, 577–581, DOI: 10.1016/S1359-835X(02)00003-9.
- 269 5. Jiang, B.; Wang, H.; Wen, G.; Wang, E.; Fang, X.; Liu, G.; Zhou, W. Copper-graphite-copper sandwich:  
270 superior heat spreader with excellent heat-dissipation ability and good weldability. *RSC Adv.* **2016**, *6*,  
271 25128–25136, DOI: 10.1039/c6ra00057f.
- 272 6. Ngo, Q.; Cruden, B.A.; Cassell, A.M.; Sims, G.; Meyyappan, M.; Li, J.; Yang, C.Y. Thermal interface  
273 properties of Cu-filled vertically aligned carbon nanofiber arrays. *Nano Lett.* **2004**, *4*, 2403–2407, DOI:  
274 10.1021/nl048506t.
- 275 7. Balandin, A.A. Thermal properties of graphene, carbon nanotubes and nanostructured carbon materials.  
276 *Nat. Mater.* **2011**, *10*, 569–581, DOI: 10.1038/nmat3064.
- 277 8. Lin, W.; Yuan, J.; Sundén, B. Review on graphite foam as thermal material for heat exchangers. In energy  
278 end-use efficiency issues (EEE), Proceedings of world renewable energy congress 2011-Sweden,  
279 Linköping, Sweden, May 8-13, 2011; B. Moshfegh; Linköping University Electronic Press; 748–755.
- 280 9. Santos, N.F.; Holz, T.; Santos, T.; Fernandes, A.J.S.; Vasconcelos, T.L.; Gouvea, C.P.; Archanjo, B.S.; Achete,  
281 C.A.; Silva, R.F.; Costa, F.M.. Heat dissipation interfaces based on vertically aligned diamond/graphite  
282 nanoplatelets. *ACS Appl. Mater. Interfaces* **2015**, *7*, 24772–24777, DOI: 10.1021/acsami.5b07633.
- 283 10. Wang, Q.; Han, X.H.; Sommers, A.; Park, Y.; Joen, C.T.; Jacobi, A. A review on application of carbonaceous  
284 materials and carbon matrix composites for heat exchangers and heat sinks. *Int. J. Refrig.* **2012**, *35*, 7–26,  
285 DOI: 10.1016/j.ijrefrig.2011.09.001.
- 286 11. Wang, L.; Gao, Y.; Xue, Q.; Liua, H.; Xu, T. Effects of nano-diamond particles on the structure and  
287 tribological property of Ni-matrix nanocomposite coatings. *Mater. Sci. Eng. A* **2005**, *390*, 313–318, DOI:  
288 10.1016/j.msea.2004.08.033.
- 289 12. Burkat, G.K.; Fujimura, T.; Dolmatov, V.Y.; Orlova, E.A.; Veretennikova, M.V. Preparation of composite  
290 electrochemical nickel-diamond and iron-diamond coatings in the presence of detonation synthesis  
291 nanodiamonds. *Diamond Relat. Mater.* **2005**, *14*, 1761–1764, DOI: 10.1016/j.diamond.2005.08.004.
- 292 13. Medelienė, V.; Stankevič, V.; Grigučevičienė, A.; Selskienė, A.; Bikulčiu, G. The study of corrosion and  
293 wear resistance of copper composite coatings with inclusions of carbon nanomaterials in the copper metal  
294 matrix. *Materials Science* **2011**, *17*, 132–139, DOI: 10.5755/j01.ms.17.2.481.
- 295 14. Shakoar, A.R.; Waware S.U.; Ali K.; Kahraman R.; Popelka A.; Yusuf M.M.; Hasan A. Novel  
296 electrodeposited Ni-B/Y<sub>2</sub>O<sub>3</sub> composite coatings with improved properties. *Coatings* **2017**, *7*, 161, DOI:  
297 10.3390/coatings7100161.
- 298 15. Praveen, B.M.; Venkatesha, T.V. Generation and corrosion behavior of Zn-Nano sized carbon black  
299 composite coating. *Int. J. Electrochem. Sci.*, **2009**, *4*, 258–266

- 300 16. Pumera, M. Nanocarbon electrochemistry. In *Electrochemistry: Volume 11-Nanosystems Electrochemistry*;  
301 Wadhawan, J.D.; Compton, R.G.; Royal Society of Chemistry, London, United Kingdom, 2012; Volume  
302 11, pp. 104–123, 978-1-84973-401-1.
- 303 17. Kuo, S.L.; Chen, Y.C.; Ger, M.D.; Hwu, W.H. Nano-particles dispersion effect on Ni/Al<sub>2</sub>O<sub>3</sub> composite  
304 coatings. *Mater. Chem. Phys.* **2004**, *86*, 5–10, DOI: 10.1016/j.matchemphys.2003.11.040.
- 305 18. Güler, E.S. Effects of electroplating characteristics on the coating properties. In *Electrodeposition of*  
306 *Composite Materials*; Mohamed, A.M.A.; Golden, T.D.; InTech, Rijeka, Croatia, 2016; 27–37,  
307 978-953-51-2270-8.
- 308 19. Shrestha, N.K.; Saji, T. Composite plating using an electro-active surfactant~ A new approach to  
309 incorporate high amount of ceramic particles into a metal matrix. *J. Surf. Finish. Soc. Jpn.* **2006**, *57*, 489–496,  
310 DOI: 10.4139/sfj.57.489.
- 311 20. Arai, S.; Saito, T.; Endo, M. Cu–MWCNT composite films fabricated by electrodeposition. *J. Electrochem.*  
312 *Soc.* **2010**, *157*, D147–D153, DOI: 10.1149/1.3280034.
- 313 21. Gibson, N.; Shenderova, O.; Luo, T.J.M.; Moseenkov, S.; Bondar, V.; Puzyr, A.; Purtov, K.; Fitzgerald, Z.;  
314 Brenner, D.W. Colloidal stability of modified nanodiamond particles. *Diamond Relat. Mater.* **2009**, *18*,  
315 620–626, DOI: 10.1016/j.diamond.2008.10.049.
- 316 22. Xu, X.; Yu, Z.; Zhu, Y.; Wang, B. Influence of surface modification adopting thermal treatments on  
317 dispersion of detonation nanodiamond. *J. Solid State Chem.* **2005**, *178*, 688–693, DOI:  
318 10.1016/j.jssc.2004.12.025.
- 319 23. Kharissova, O.V.; Kharisov, B.I.; Ortiz, E.G.C. Dispersion of carbon nanotubes in water and non-aqueous  
320 solvents. *RSC Adv.* **2013**, *3*, 24812–24852, DOI: 10.1039/c3ra43852j.
- 321 24. Moraes, R.A.; Matos, C.F.; Castro, E.G.; Schreiner, W.H.; Oliveira, M.M.; Zarbin, A.J.G. The effect of  
322 different chemical treatments on the structure and stability of aqueous dispersion of iron- and iron  
323 oxide-filled multi-walled carbon nanotubes. *J. Braz. Chem. Soc.* **2011**, *22*, 2191–2201, DOI:  
324 10.1590/S0103-50532011001100024.
- 325 25. Cheng, J.; He, J.; Li, C.; Yang, Y. Facile approach to functionalize nanodiamond particles with V-shaped  
326 polymer brushes. *Chem. Mater.* **2008**, *20*, 4224–4230, DOI: 10.1021/cm800357g.
- 327 26. Aal, A.A.; Bahgat, M.; Radwan, M. Nanostructured Ni–AlN composite coatings. *Surf. Coat. Technol.* **2006**,  
328 *201*, 2910–2918, DOI: 10.1016/j.surfcoat.2006.06.002.
- 329 27. Bahrololoom, M.E.; Sani, R. The influence of pulse plating parameters on the hardness and wear resistance  
330 of nickel–alumina composite coatings. *Surf. Coat. Technol.* **2005**, *192*, 154–163, DOI:  
331 10.1016/j.surfcoat.2004.09.023.
- 332 28. GUO, D.; ZHANGy, M.; JIN, Z.; KANG, R. Pulse plating of copper-ZrB<sub>2</sub> composite coatings. *J. Mater. Sci.*  
333 *Technol.* **2006**, *22*, 514–518
- 334 29. Krueger, A.; Lang, D. Functionality is key: recent progress in the surface modification of nanodiamond.  
335 *Adv. Funct. Mater.* **2012**, *22*, 890–906, DOI: 10.1002/adfm.201102670.
- 336 30. Jiang, Z.; Liu, Y.; Sun, X.; Tian, F.; Sun, F.; Liang, C.; You, W.; Han, C.; Li, C. Activated carbons chemically  
337 modified by concentrated H<sub>2</sub>SO<sub>4</sub> for the adsorption of the pollutants from wastewater and the  
338 dibenzothiophene from fuel oils. *Langmuir* **2003**, *19*, 731–736, DOI: 10.1021/la020670d.
- 339 31. Matsubara, H. Fabrication of novel materials by the incorporation of nanodiamond into plated films. *J.*  
340 *Surf. Sci. Soc. Jpn.* **2009**, *30*, 279–286, DOI: 10.1380/jsssj.30.279.